In cases where the application will demand a high level of reliability, such as automotive, please contact a company representative for further information.

Applicabl	e standard							
11	Operating temperature range		-35°C to +85°C(Notes 1) Stor		age perature range	-10°C to +60°C(Note3)		
Rating	Operating humidity range		20 % to 80 % (Notes 2)	Stor		40 % to 70 %(Note3)		
	Voltage		150 V AC (DC)	Current		1 A/pin		
	Applicable		DF13-*DS-1.25C Apr		licable	DF13(G)-2630SCFA(#		£)
Connector					tact	DF13-3032SCFA(##)		,
			Specifica	tions	S			
Item		Test method			Requirements		QT	AT
Construc	tion							
General examination		Visually and by measuring instrument.			According to drawing.		Х	Χ
Marking	Marking		Confirmed visually.					
Electric o	haracteris	tics			П		1	
Contact resis	stance	AC 20mV, 1mA (DC OR 1000 Hz).			30 mΩ MAX.		Х	_
Insulation res	Insulation resistance		100 V DC.			500 MΩ MIN.		_
Voltage proof		500 V AC for 1 min.			No flashover or breakdown.		Х	_
Mechani	cal charact	eristics			П			
Mechanical operation		50 times insertions and extractions.			 Contact resistance: 30 mΩ MAX. No damage, crack or looseness of parts. 		Х	_
Vibration		Frequency 10 to 55 Hz, single amplitude 0.75 mm, at 2 h, for 3 directions.			1) No electrical discontinuity of 1µs. 2) No damage, crack or looseness of parts.			_
Shock		490 m/s ² duration of pulse 11 ms at 3 times for 3 directions.						_
Environn	nental char				-1		1	
			ture -55°C→ +85°C	1) Contact resistance: 30mΩ MAX.				
temperature		· ·			2) Insulation resistance: 500 MΩ MIN.3) No damage, crack or looseness of parts.			_
Damp heat		(The transferring time of the tank is 2 to 3 MIN) Exposed at 40±2 °C, 90 to 95 %, 96 h.						
(Steady state))	Exposed	at 40±2 °C, 90 to 95 %, 96 ff.				X	_
Resistance to soldering heat		1) Reflow soldering « Reflow area »			No deformation of case of excessive looseness of the terminals.		Х	_
			C MAX 10 sec MAX C MIN 60 sec MAX					
		≪ Preheating area ≫ 170°C to 190°C 60 sec to 120 sec Put through in reflow furnace twice, leave in ambient temperature and humidity for 1 hour. 2) Manual soldering Soldering iron temperature :300°C,						
			ng time: 3sec.				1	
Solderability			at solder temperature,		Solder shall cover a	minimum of	X	
Colderability		245°c for insertion duration, 3sec.			95 % of the surface being immersed.			-
<u> </u>		2-70 0 101	mooraon daration, 0360.		JO 70 OF THE SUITACE	, some initiologu.	1	

Remarks

Note 1: Include the temperature rising by current.

Note 2: No condensing

Note 3: Apply to the condition of long term storage for unused products before mounted on PCB.

After mounted on PCB, operating temperature and humidity range is applied for interim storage during transportation.

Coun	t Description of revisions	Designed			Checked	Date
\triangle						
Unless otherwise specified, refer to IEC 60512.			Ар	proved	HS. OKAWA	20200316
			Ch	ecked	TS. KUMAZAWA	20200316
			Designed		HK. HAYASHI	20200316
			Drawn		DS. HIROWATARI	20200311
Note QT:Qualification Test AT:Assurance Test X:Applicable Test			Drawing no.		ELC-367983-65-00	
жs	Specification sheet		Part no.	DF13E-*DP-1. 25V (65)		(65)
11.0	Hirose electric co., ltd.		Code no.	CL536		<u></u> 1/1



